

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	
Execution Date	
Chang Hyun Lim	08/17/2011
Young Ki Lee	08/17/2011
Kwang Soo Kim	08/17/2011
Seog Moon Choi	08/17/2011
RECEIVING PARTY DATA	
Name:	Samsung Electro-Mechanics Co., LTD
Street Address:	314 Maetan 3-dong Yeongtong-gu
Internal Address:	Suwon
City:	Gyeonggi-do
State/Country:	REPUBLIC OF KOREA
Postal Code:	443-743
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	13247603
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ATTORNEY DOCKET NUMBER:	B-7163 626644
NAME OF SUBMITTER:	Joseph M. Kobzeff
Total Attachments: 3 source=626644_assignment#page1.tif source=626644_assignment#page2.tif source=626644_assignment#page3.tif	

OP \$40.00 13247603

Attorney's Docket No.

B-7163 626644-2

Patent

For: U.S. and/or Foreign Rights
For: U.S. Application or U.S. Patent
For: PCT Application
By: Inventor(s) or Present Owner

ASSIGNMENT OF INVENTION

In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration,

ASSIGNORS:
(inventor(s) or person(s) or
entity(ies) who own the invention)

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(Address)

Korea
(Nationality)

(Assignment of Invention [16-3]--page 1 of 5)

hereby confirm that ASSIGNORS sell, assign and transfer to

ASSIGNEE:

SAMSUNG ELECTRO-MECHANICS CO., LTD.

(type or print name(s) of ASSIGNEE(S))

314, Maetan 3-dong, Yeongtong-gu,

Suwon, Gyunggi-do 443-743, Korea

(Address)

Korea

(Nationality)

and the successors, assigns and legal representatives of the ASSIGNEE
(complete one of the following)

the entire right, title and interest

an undivided _____ percent (_____ %) interest for the

United States and its territorial possessions

(check the following box if foreign rights are also to be assigned)

and in all foreign countries, including all rights to claim

priority, in and to any and all improvements which are disclosed in the invention
entitled :

POWER MODULE PACKAGE AND METHOD FOR MANUFACTURING THE
SAME

(check and complete (a), (b), (c) or (d)) and which is found in

(a) U.S. patent application executed on even date herewith

(b) U.S. patent application executed on _____

To comply with 37 CFR 3.21 for recordal of this assignment, I, an
ASSIGNOR signing below, hereby authorize and request my attorney, as named
in the Declaration and Power of Attorney I executed for this invention on the
execution date stated above, to insert below the filing date and application
number when it becomes known.

(c) U.S. Application serial no. _____ filed on _____

(d) International application no. _____

(e) U.S. Patent no. _____ issued _____

A change of address to which correspondence is to be sent regarding patent
maintenance fees is being sent separately.

(also check (F) if foreign application(s) is also being assigned)

(f) and any legal equivalent thereof in a foreign country, including the right to
claim priority and, in and to, all Letters Patent to be obtained for said invention by the
above application or any continuation, division, renewal, or substitute thereof, and as to
Letters Patent any reissue or re-examination thereof

ASSIGNORS hereby covenant that no assignment, sale, agreement or
encumbrance has been or will be made or entered into which would conflict with this
assignment;

ASSIGNORS further covenant that ASSIGNEE will, upon its request, be
provided promptly with all pertinent facts and documents relating to said invention and

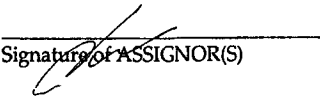
said Letters Patent and legal equivalents as may be known and accessible to ASSIGNORS and will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the purposes thereof.

IN WITNESS WHEREOF, I/We have hereunto set hand and seal this

17th day of August, 2011 (date of signing).

LIM, Chang Hyun

Name of Assignor(s)

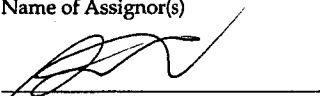

Signature of ASSIGNOR(S)

IN WITNESS WHEREOF, I/We have hereunto set hand and seal this

17th day of August, 2011 (date of signing).

LEE, Young Ki

Name of Assignor(s)


Signature of ASSIGNOR(S)

IN WITNESS WHEREOF, I/We have hereunto set hand and seal this

17th day of August, 2011 (date of signing).

KIM, Kwang Soo

Name of Assignor(s)

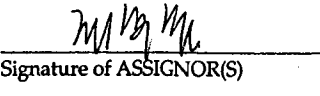

Signature of ASSIGNOR(S)

IN WITNESS WHEREOF, I/We have hereunto set hand and seal this

17th day of August, 2011 (date of signing).

CHOI, Seog Moon

Name of Assignor(s)


Signature of ASSIGNOR(S)

(Assignment of Invention [16-3]-page 3 of 5)